

**2N4220
thru
2N4222**

**2N4220,A
thru
2N4222,A**

**CASE 20-03, STYLE 3
TO-72 (TO-206AF)**

**JFET
LOW-FREQUENCY, LOW NOISE**

N-CHANNEL — DEPLETION

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	Vdc
Drain-Gate Voltage	V_{DG}	30	Vdc
Gate-Source Voltage	V_{GS}	-30	Vdc
Drain Current	I_D	15	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	300 2	mW mW/ $^\circ\text{C}$
Junction Temperature Range	T_J	175	$^\circ\text{C}$
Storage Channel Temperature Range	T_{stg}	-65 to +200	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Gate-Source Breakdown Voltage ($I_G = -10 \mu\text{Adc}$, $V_{DS} = 0$)	$V_{(BR)GSS}$	-30	—	—	Vdc
Gate Reverse Current ($V_{GS} = -15 \text{Vdc}$, $V_{DS} = 0$) ($V_{GS} = -15 \text{Vdc}$, $V_{DS} = 0$, $T_A = 150^\circ\text{C}$)	I_{GSS}	—	—	-0.1 -100	nAdc
Gate Source Cutoff Voltage ($I_D = 0.1 \text{nAdc}$, $V_{DS} = 15 \text{Vdc}$)	$V_{GS(off)}$	—	—	-4 -6 -8	Vdc
Gate Source Voltage ($I_D = 50 \mu\text{Adc}$, $V_{DS} = 15 \text{Vdc}$) ($I_D = 200 \mu\text{Adc}$, $V_{DS} = 15 \text{Vdc}$) ($I_D = 500 \mu\text{Adc}$, $V_{DS} = 15 \text{Vdc}$)	V_{GS}	-0.5 -1.0 -2.0	—	-2.5 -5.0 -6.0	Vdc

ON CHARACTERISTICS

Zero-Gate-Voltage Drain Current* ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$)	I_{DSS}	0.5 2.0 5.0	—	3.0 6.0 15	mAdc
Static Drain-Source On Resistance ($V_{DS} = 0$, $V_{GS} = 0$)	$r_{DS(on)}$	—	500 400 300	—	Ohms

SMALL-SIGNAL CHARACTERISTICS

Forward Transfer Admittance Common Source* ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{kHz}$)	$ y_{fs} $	1000 2000 2500	—	4000 5000 6000	μmhos
Output Admittance Common Source ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{kHz}$)	$ y_{os} $	—	—	10 20 40	μmhos
Input Capacitance ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{MHz}$)	C_{iss}	—	4.5	6.0	pF
Reverse Transfer Capacitance ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{MHz}$)	C_{rss}	—	1.2	2.0	pF
Common-Source Output Capacitance ($V_{DS} = 15 \text{Vdc}$, $V_{GS} = 0$, $f = 30 \text{MHz}$)	C_{osp}	—	1.5	—	pF

2N4220 thru 2N4222, 2N4220A thru 2N4222A

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL CHARACTERISTICS					
Noise Figure ($V_{DS} = 15\text{ Vdc}$, $V_{GS} = 0$, $R_S = 1.0\text{ megohm}$, $f = 100\text{ Hz}$)	NF	—	—	2.5	dB
		—	—	2.5	
		—	—	2.5	

*Pulse Test: Pulse Width = 630 ms, Duty Cycle = 10%.

FIGURE 1 — NOISE FIGURE versus FREQUENCY

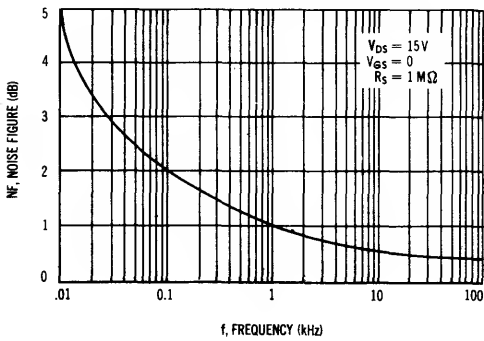


FIGURE 2 — NOISE FIGURE versus SOURCE RESISTANCE

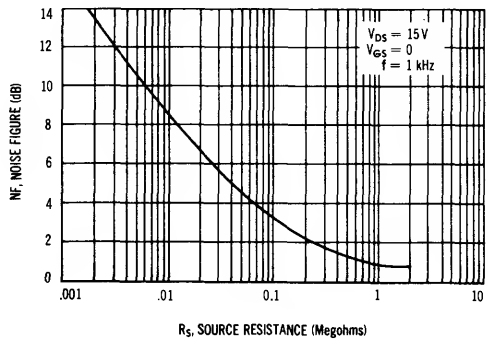


FIGURE 3 — TYPICAL DRAIN CHARACTERISTICS
 $V_{GS(\text{off})} \cong -1.2\text{ VOLTS}$

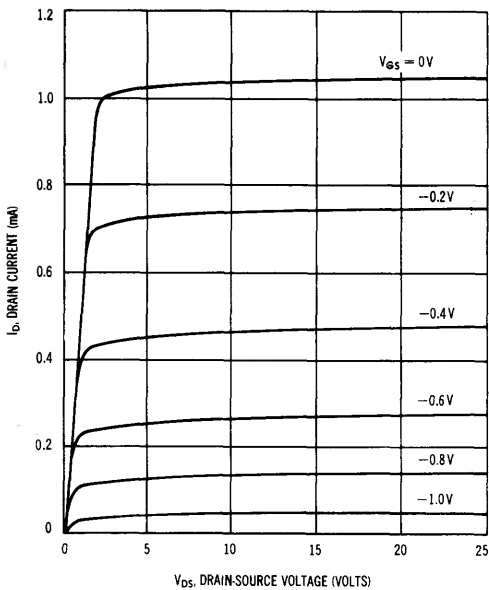
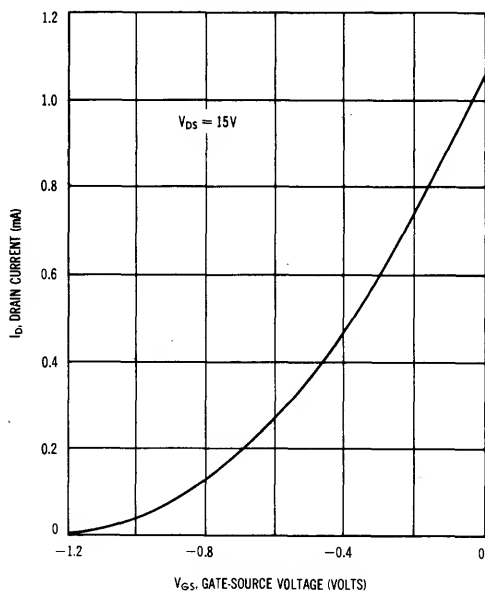


FIGURE 4 — COMMON SOURCE TRANSFER CHARACTERISTICS
 $V_{GS(\text{off})} \cong -1.2\text{ VOLTS}$



2N4220 thru 2N4222, 2N4220A thru 2N4222A

FIGURE 5 — TYPICAL DRAIN CHARACTERISTICS
 $V_{GS(off)} \cong -3.5$ VOLTS

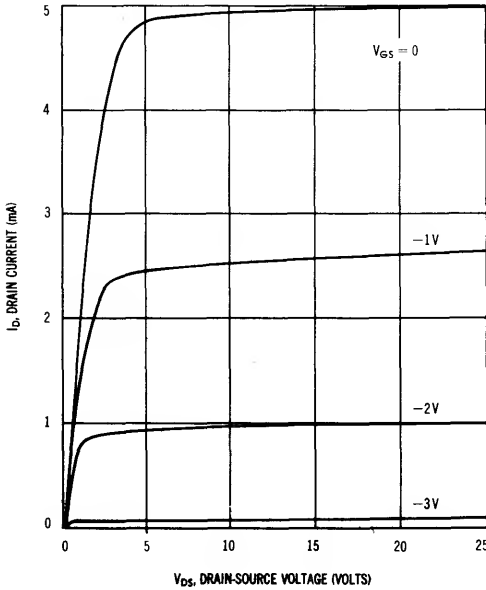


FIGURE 6 — COMMON SOURCE TRANSFER CHARACTERISTICS
 $V_{GS(off)} \cong -3.5$ VOLTS

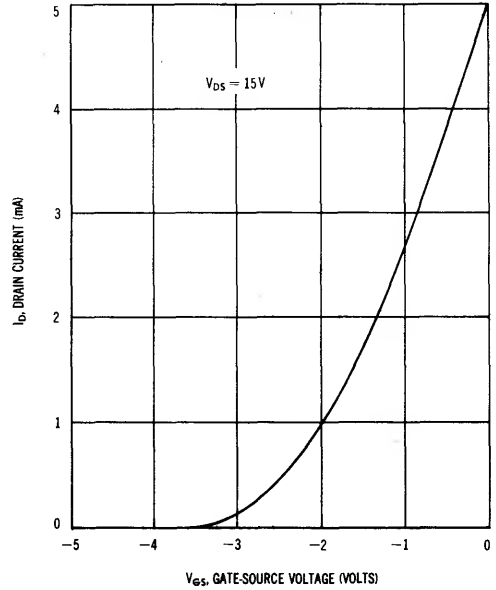


FIGURE 7 — TYPICAL DRAIN CHARACTERISTICS
 $V_{GS(off)} \cong -5.8$ VOLTS

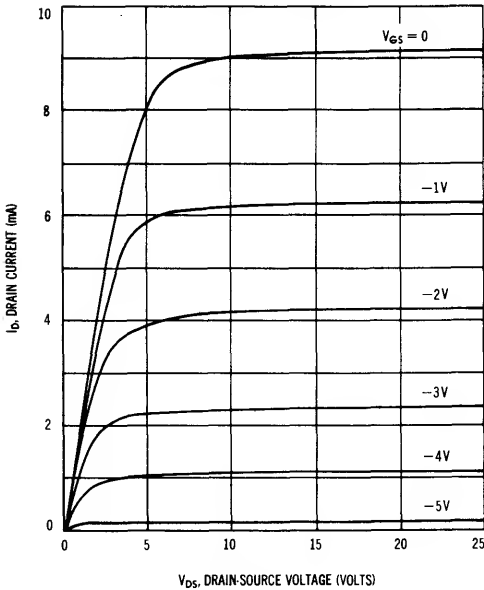
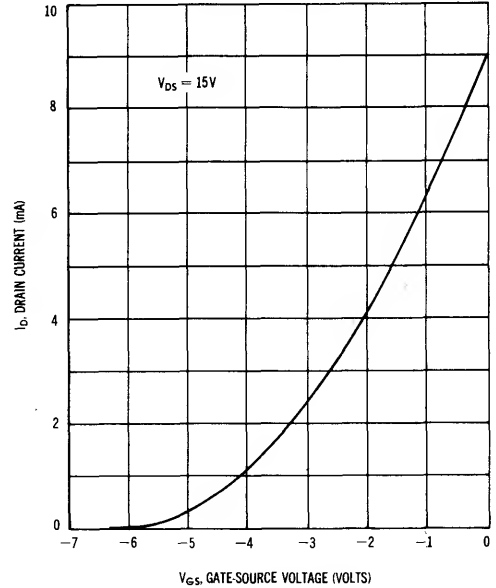


FIGURE 8 — COMMON SOURCE TRANSFER CHARACTERISTICS
 $V_{GS(off)} \cong -5.8$ VOLTS



- NOTES:**
1. Graphical data is presented for dc conditions. Tabular data is given for pulsed conditions (Pulse Width = 630 ms, Duty Cycle = 10%). Under dc conditions, self heating in higher I_{DSS} units reduces I_{DSS} (See Figure 10).
 2. Figures 8, 9, 10: Data taken in a standard printed circuit with a TO-18 type socket mounting and 1/4" lead length.

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